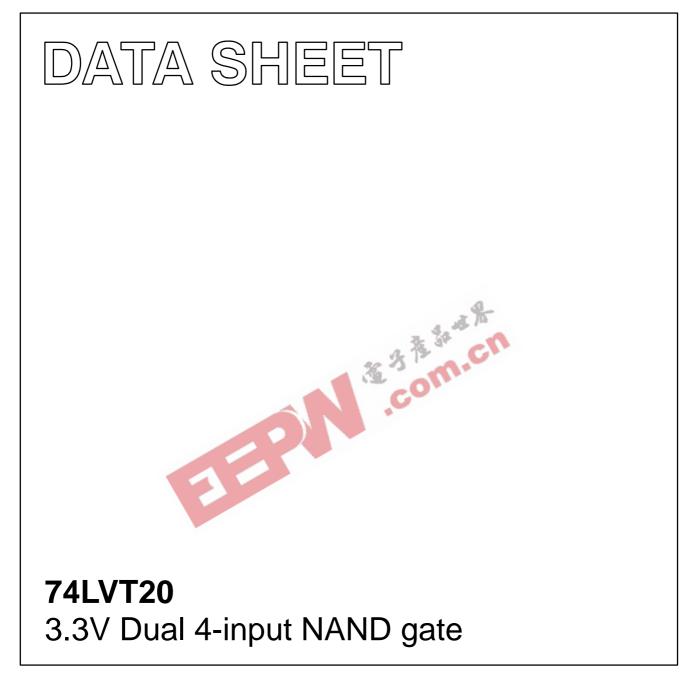
## INTEGRATED CIRCUITS



Product specification

1996 Aug 28

IC24 Data Handbook



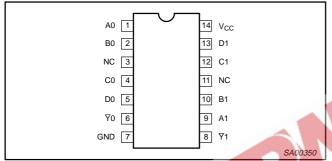


## 74LVT20

#### QUICK REFERENCE DATA

SYMBOL	PARAMETER	ETER $T_{amb} = 25^{\circ}C;$ GND = 0V		PARAMETER T <sub>amb</sub> = 25°C; TYPICAL		UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An, Bn, Cn, Dn to Ƴn	C <sub>L</sub> = 50pF; V <sub>CC</sub> = 3.3V	3.4 3.2	ns		
C <sub>IN</sub>	Input capacitance	$V_{I} = 0V \text{ or } 3.0V$	3	pF		
I <sub>CCL</sub>	Total supply current	Outputs Low; V <sub>CC</sub> = 3.6V	0.5	mA		

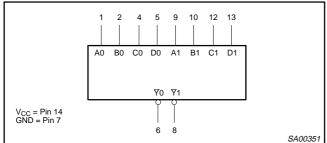
### **PIN CONFIGURATION**



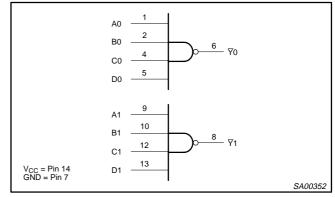
#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 2, 4, 5, 9, 10, 12, 13	An, Bn, Cn, Dn	Data inputs
6, 8	₹n	Data outputs
7	GND	Ground (0V)
14	V <sub>CC</sub>	Positive supply voltage

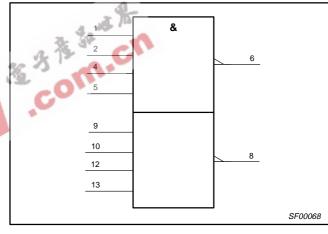
### LOGIC SYMBOL



#### LOGIC DIAGRAM



### LOGIC SYMBOL (IEEE/IEC)



#### **FUNCTION TABLE**

	INP	OUTPUT		
Dna	Dnb	Dnc	Dnd	Qn
L	Х	Х	Х	Н
Х	L	Х	Х	Н
Х	Х	L	Х	Н
Х	Х	Х	L	Н
Н	Н	Н	Н	L
NOTES				

NOTES:

H = High voltage level L = Low voltage level X = Don't care

#### **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
14-Pin Plastic SO	–40°C to +85°C	74LVT20 D	74LVT20 D	SOT108-1
14-Pin Plastic SSOP	-40°C to +85°C	74LVT20 DB	74LVT20 DB	SOT337-1
14-Pin Plastic TSSOP	-40°C to +85°C	74LVT20 PW	74LVT20PW DH	SOT402-1

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#### ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +4.6	V
I <sub>IK</sub>	DC input diode current	V <sub>1</sub> < 0	-50	mA
VI	DC input voltage <sup>3</sup>		-0.5 to +7.0	V
Ι <sub>ΟΚ</sub>	DC output diode current	V <sub>O</sub> < 0	-50	mA
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	Output in Off or High state	-0.5 to +7.0	V
		Output in High state	-32	
IOUT	DC output current	Output in Low state	64	- mA
T <sub>stg</sub>	Storage temperature range		-65 to 150	°C

NOTES:

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction

the performance capacity of a high performance integrated check in conjunction with the anomal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	LIMITS		UNIT
STWBOL	PARAMETER	MIN	MAX	UNIT
V <sub>CC</sub>	DC supply voltage	2.7	3.6	V
VI	Input voltage	0	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0		V
V <sub>IL</sub>	Low-level Input voltage		0.8	V
I <sub>ОН</sub>	High-level output current		-20	mA
	Low-level output current		32	
I <sub>OL</sub>	Low-level output current; current duty cycle $\leq$ 50%, f $\geq$ 1kHz		48	mA
T <sub>amb</sub>	Operating free-air temperature range	-40	+85	°C

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#### DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions Voltages are referenced to GND (ground = 0V)

			LIMITS Temp = -40°C to +85°C			UNIT	
SYMBOL	PARAMETER	TEST CONDITIONS					
			MIN	TYP <sup>1</sup>	MAX	1	
V <sub>IK</sub>	Input clamp voltage	$V_{CC} = 2.7V; I_{IK} = -18mA$			-1.2	V	
		$V_{CC} = 2.7$ to 3.6V; $I_{OH} = -100\mu A$	V <sub>CC</sub> -0.2				
V <sub>OH</sub>	High-level output voltage	$V_{CC} = 2.7V; I_{OH} = -6mA$	2.4			V	
		$V_{CC} = 3.0V; I_{OH} = -20mA$	2.0		1		
		$V_{CC} = 2.7V; I_{OL} = 100\mu A$			0.2		
V <sub>OL</sub>	Low-level output voltage	V <sub>CC</sub> = 2.7V; I <sub>OL</sub> = 24mA			0.5	V	
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 32mA	0.5	1			
		$V_{CC} = 0 \text{ or } 3.6V; V_I = 5.5V$	10		μA		
łı	Input leakage current	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or } GND$	±1				
I <sub>OFF</sub>	Output off current	$V_{CC} = 0V; V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5V$			±100	μΑ	
I <sub>ССН</sub>		$V_{CC}$ = 3.6V; Outputs High, $V_{I}$ = GND or $V_{CC}$ , $I_{O}$ = 0			0.02	mA	
I <sub>CCL</sub>	Quiescent supply current	$V_{CC} = 3.6V$ ; Outputs Low, $V_1 = GND$ or $V_{CC}$ , $I_0 = 0$		0.5	1.2	mA	
$\Delta I_{CC}$	Additional supply current per input pin <sup>2</sup>	$V_{CC} = 3V$ to 3.6V; One input at $V_{CC}$ -0.6V, Other inputs at $V_{CC}$ or GND			0.2	μA	
CI	Input capacitance	$V_1 = 3V$ or 0		3		pF	

NOTES:

1. All typical values are at  $V_{CC} = 3.3V$  and  $T_{amb} = 25^{\circ}C$ . 2. This is the increase in supply current for each input at the specificed voltage level other than  $V_{CC}$  or GND.

#### **AC CHARACTERISTICS**

GND = 0V; t<sub>R</sub> = t<sub>F</sub> = 2.5ns; C<sub>L</sub> = 50pF, R<sub>L</sub> = 500 $\Omega$ ; T<sub>amb</sub> = -40°C to +85°C.

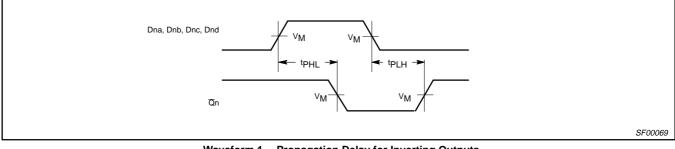
			LIMITS				
SYMBOL	PARAMETER	WAVEFORM	$V_{CC} = 3.3V \pm 0.3V$			$V_{CC} = 2.7V$	UNIT
			MIN	TYP <sup>1</sup>	MAX	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An, Bn, Cn, Dn to Yn	1	1.0 1.0	3.4 3.2	5.4 4.4	6.4 4.3	ns

NOTE:

1. All typical values are at  $V_{CC} = 3.3V$  and  $T_{amb} = 25^{\circ}C$ .

#### AC WAVEFORMS

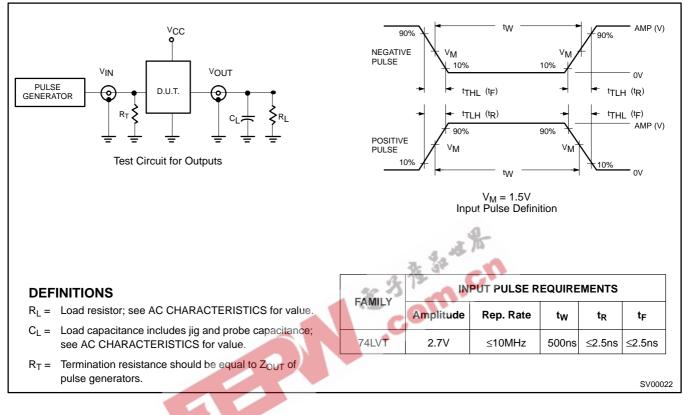
 $V_{M}$  = 1.5V,  $V_{IN}$  = GND to 2.7V

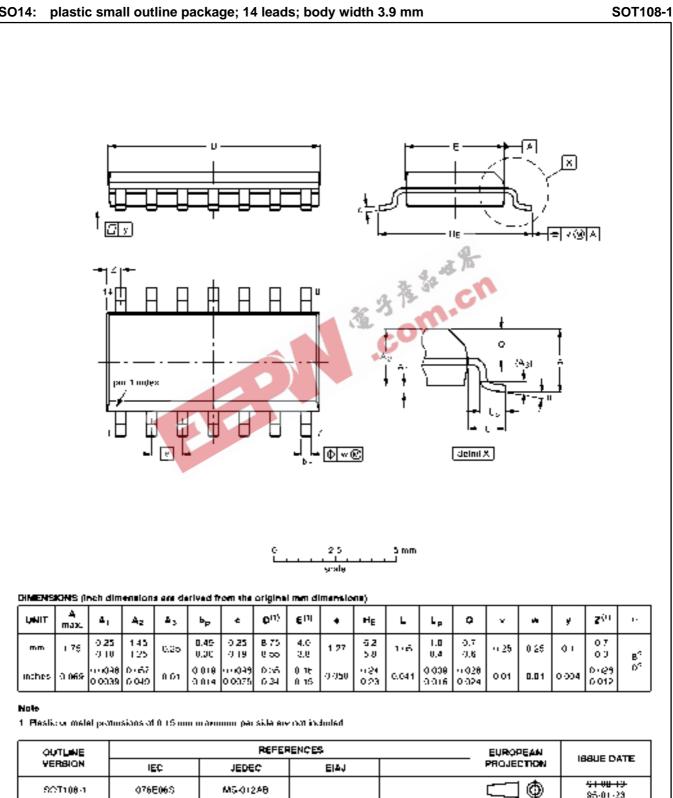


Waveform 1. Propagation Delay for Inverting Outputs

### 74LVT20

#### **TEST CIRCUIT AND WAVEFORMS**





# SO14:

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SOT108-1

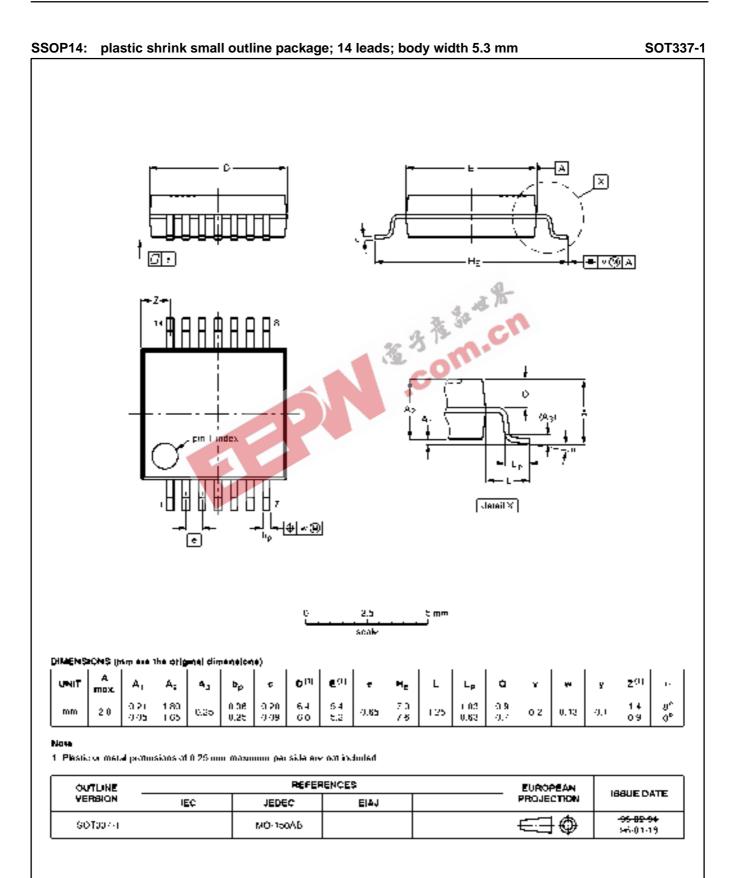
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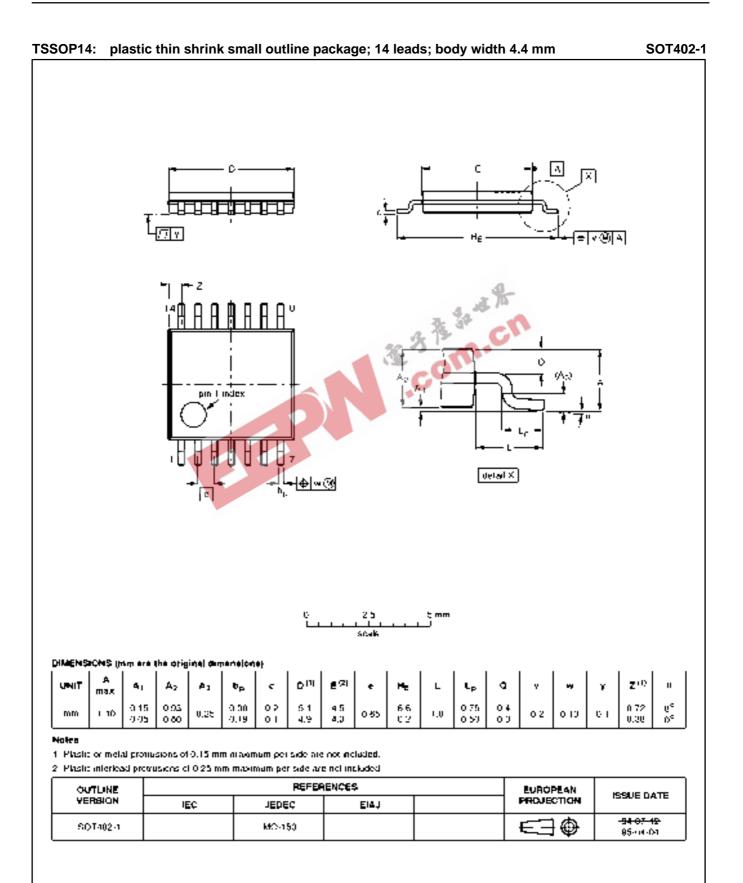
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### 74LVT20

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## 3.3V Dual 4-input NAND gate



74LVT20

NOTES



### 74LVT20



DEFINITIONS				
Data Sheet Identification	Product Status	Definition		
Objective Specification	<i>ive Specification</i> Formative or in Design This data sheet contains the design target or goal specifications for product development. may change in any manner without notice.			
Preliminary Specification Preproduction Product		This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.		
Product Specification	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.		

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